

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT3376027

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
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MR. JUN LUO	05/20/2015
MR. CHUNLONG LI	05/20/2015
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14647360
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DATE SIGNED:	06/01/2015
Total Attachments: 1	
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JOINT ASSIGNMENT

We, as a below-named Assignor, have invented a certain new and useful invention relating to "METHOD FOR MANUFACTURING FIN STRUCTURE," for which a CN patent application was filed on November 30, 2012 in the State Intellectual Property Office of the People's Republic of China, having a Serial Number of 201210505760.9, a PCT Application was filed on December 12, 2012 (claiming priority to CN 201210505760.9) having a Patent Application No. PCT/CN2012/086743, and a U.S. National Stage Entry Patent Application was filed on May 26, 2015, having a Serial Number of 14/647,360. (I hereby authorize and request the attorneys associated with Customer Number 19227 to insert here the filing date and application number of this application when known).

For good and valuable consideration, receipt of which is hereby acknowledged, I hereby sell, assign, and transfer to **Institute of Microelectronics, Chinese Academy of Sciences**, having a place of business at No. 3 Beitucheng West Road, Chaoyang District, Beijing, China, 100029, its successors, assigns, and legal representatives, including any nominees (collectively "the Assignee"), the entire and exclusive right, title, and interest in said invention, the foregoing application and all other United States, foreign and international patent applications associated therewith, based thereon, or claiming priority therefrom including, but not limited to, any and all provisionals, nonprovisionals, divisionals, continuations, continuations-in-part, re-examinations, reissues, and extensions thereof, and the right to claim priority thereto, and the entire and exclusive right, title, and interest in and to any and all patents granted on these applications.

We authorize and request that the Patent Office officials in the United States and in any and all foreign countries to issue any and all Letters Patent when granted, solely to **Institute of Microelectronics, Chinese Academy of Sciences**, for its sole use, and that of its successors, assigns, and legal representatives.

We will provide my cooperation to enable the Assignee to enjoy the foregoing right, title, and interest to the fullest extent. Upon request at the expense of the Assignee, I agree to execute all papers, take all rightful oaths, testify in all legal proceedings including patent prosecutorial actions and infringement actions, and do all other such acts which may be necessary, desirable, or convenient for securing and maintaining patents on the foregoing invention or for perfecting title thereto in the Assignee.

We certify that we have the full right to convey the above rights.

May 20, 2015

Date

ZHU, Huilong

Assignor

May 20, 2015

Date

LUO, Jun

Assignor

May 20, 2015

Date

LI, Chunlong

Assignor

PATENT